



30V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C	
N. Observat	00)/	25mΩ @ V _{GS} = 10V	6.0A	
N-Channel 30V	40mΩ @ V _{GS} = 4.5V	4.6A		
D. Ohaanaal	001/	$50m\Omega$ @ $V_{GS} = -10V$	-4.2A	
P-Channel	-30V	80mΩ @ V _{GS} = -4.5V	-3.2A	

Description

This new generation complementary MOSFET H-Bridge features low on-resistance achievable with low gate drive.

Applications

- DC Motor Control
- DC-AC Inverters

Features

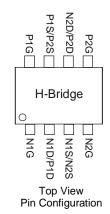
- 2 x N + 2 x P Channels in A SO-8 Package
- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMHC3025LSDQ)

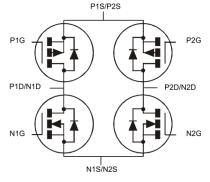
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 [®]
- Weight: 0.008 grams (Approximate)



Top View





Internal Schematic

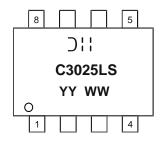
Ordering Information (Note 4)

Ī	Part Number	Case	Packaging
	DMHC3025LSD-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



⊃¦¦ = Manufacturer's Marking
 C3025LS = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Year (ex: 18 = 2018)
 WW = Week (01 to 53)



Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)		P_{D}	1.5	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	83	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	50		
Thermal Resistance, Junction to Case		R ₀ JC	14.5		
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C	

Maximum Ratings N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	30	V	
Gate-Source Voltage			V _{GSS}	±20	V
Operitoring Project Operand (Alexa 5) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.0 4.8	А
Continuous Drain Current (Note 5) V _{GS} = 10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	7.8 6.1	А
Continuous Drain Current (Note 5) V _{GS} = 4.5V Steady State t < 10s		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	4.6 3.6	А
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	6.1 4.8	А
Maximum Continuous Body Diode Forward Curren	t (Note 5)	I _S	2.5	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	60	А		

Maximum Ratings P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V_{DSS}	30	V	
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Drain Current (Note 5) V 40V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.2 -3.3	А
Continuous Drain Current (Note 5) V _{GS} = -10V	t < 10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	-5.4 -4.3	А
Continuous Drain Current (Note 5) V _{GS} = -4.5V Steady State t < 10s		$T_A = +25$ °C $T_A = +70$ °C	I _D	-3.2 -2.5	А
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.3 -3.3	А
Maximum Continuous Body Diode Forward Current	(Note 5)	I _S	-2.5	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-30	А

Note: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±1	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	V _{GS(TH)}	1	_	2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance		l	19	25	mΩ	$V_{GS} = 10V, I_D = 5A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	26	40	11177	$V_{GS} = 4.5V, I_D = 4A$
Forward Transfer Admittance	Y _{fs}	_	4	_	S	$V_{DS} = 5V$, $I_D = 5A$
Diode Forward Voltage	V _{SD}		0.70	1.2	V	V _{GS} = 0V, I _S = 1.7A
DYNAMIC CHARACTERISTICS (Note 7)						•
Input Capacitance	C _{iss}	_	590	_		
Output Capacitance	Coss	_	122	_	pF	$V_{DS} = 15V$, $V_{GS} = 0V$, $f = 1MHz$
Reverse Transfer Capacitance	C _{rss}	_	58	_		
Gate Resistance	Rq		1.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qq	_	5.4	_		
Total Gate Charge (V _{GS} = 10V)	Qq		11.7	_		V 45V L 70A
Gate-Source Charge	Q_{gs}		1.8	_	nC	$V_{DS} = 15V, I_D = 7.8A$
Gate-Drain Charge	Q_{gd}		2.1	_		
Turn-On Delay Time	t _{D(ON)}	-	11.2	_		
Turn-On Rise Time	t _R		15	_		$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(OFF)}	_	17.5	_	ns	$R_L = 2.4\Omega$, $R_G = 1\Omega$
Turn-Off Fall Time	t _F	_	8.7	_		
Reverse Recovery Time	t _{RR}	_	18.3	_	ns	
Reverse Recovery Charge	Q _{RR}	_	12	_	nC	$I_F = 12A$, di/dt = 500A/ μ s

Electrical Characteristics P-CHANNEL (@TA = +25°C, unless otherwise specified.)

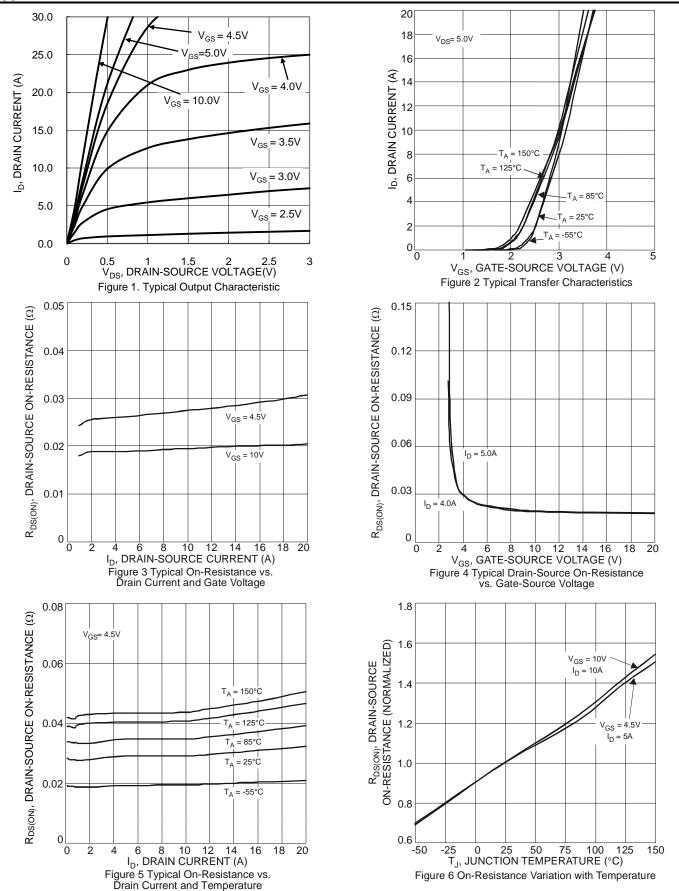
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	I	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}		1	-0.5	μΑ	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±1	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	$V_{GS(TH)}$	-1	1	-2	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance			43	50	mΩ	$V_{GS} = -10V, I_D = -5A$
Static Drain-Source On-Resistance	R _{DS(ON)}	l	68	80	11122	$V_{GS} = -4.5V$, $I_{D} = -4A$
Forward Transfer Admittance	Y _{fs}	_	3.5	_	S	$V_{DS} = -5V, I_{D} = -5A$
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1.7A$
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	C _{iss}	_	631	_	pF	45)()(0)(
Output Capacitance	Coss	_	137	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ - f = 1MHz
Reverse Transfer Capacitance	C _{rss}	_	70	_	pF	T = TIVINZ
Gate Resistance	R_g	_	10.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Q_{g}	_	5.5	_	nC	
Total Gate Charge (V _{GS} = -10V)	Qg	_	11.4	_	nC	151/ 1 60
Gate-Source Charge	Q_{gs}	_	1.8	_	nC	$V_{DS} = -15V, I_{D} = -6A$
Gate-Drain Charge	Q _{qd}	_	2.4	_	nC	1
Turn-On Delay Time	t _{D(ON)}		7.5	_	ns	
Turn-On Rise Time	t _R		4.9	_	ns	$V_{DD} = -15V, V_{GS} = -10V,$
Turn-Off Delay Time	t _{D(OFF)}		28.2	_	ns	$R_G = 6\Omega$, $I_D = -1A$
Turn-Off Fall Time	t _F		13.5	_	ns	7
Reverse Recovery Time	t _{RR}		15.1	_	ns	1 404 11/11 5004/
Reverse Recovery Charge	Q _{RR}		15.3	_	nC	I _F = -12A, di/dt = 500A/μs

Notes: 6. Short duration pulse test used to minimize self-heating effect.

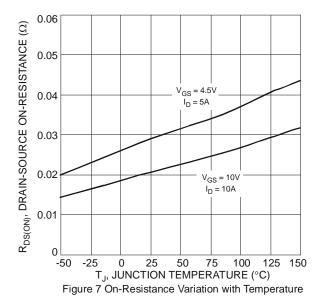
7. Guaranteed by design. Not subject to product testing.

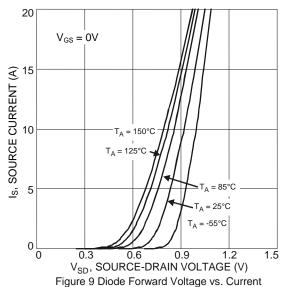


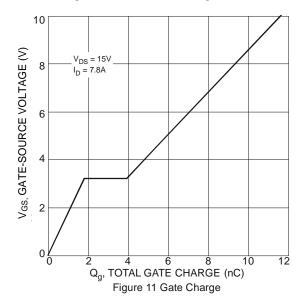
Typical Characteristics - N-CHANNEL











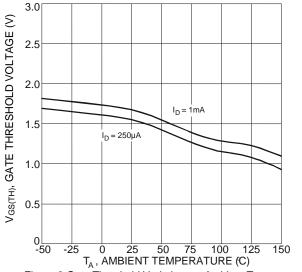
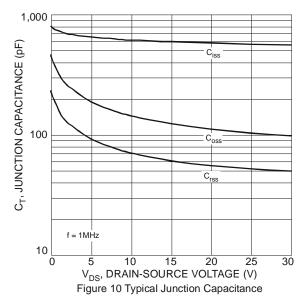
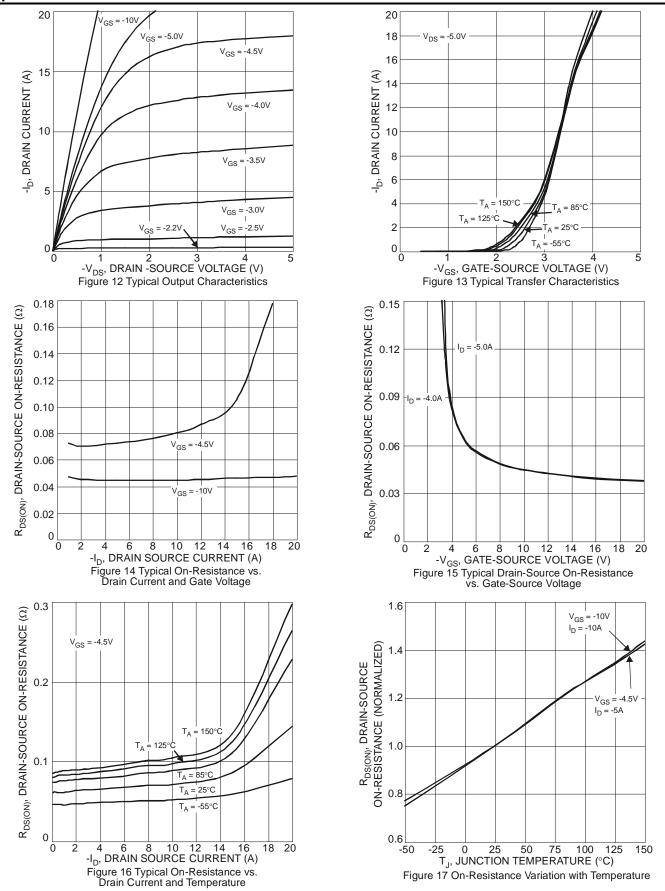


Figure 8 Gate Threshold Variation vs. Ambient Temperature





Typical Characteristics - P-CHANNEL







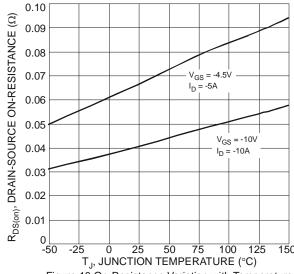
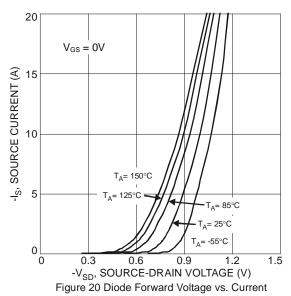


Figure 18 On-Resistance Variation with Temperature



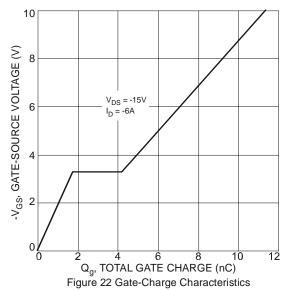
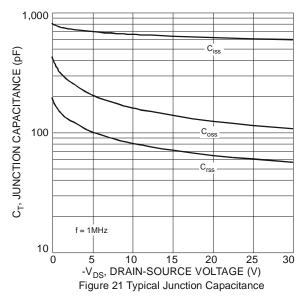


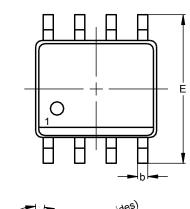
Figure 19 Gate Threshold Variation vs. Ambient Temperature

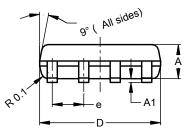


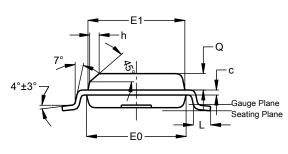


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.







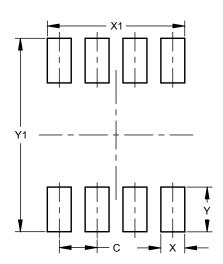
SO-8

SO-8							
Dim	Min	Max	Тур				
Α	1.40	1.50	1.45				
A1	0.10	0.20	0.15				
b	0.30	0.50	0.40				
С	0.15	0.25	0.20				
D	4.85	4.95	4.90				
E	5.90	6.10	6.00				
E1	3.80	3.90	3.85				
E0	3.85	3.95	3.90				
е			1.27				
h	-		0.35				
L	0.62	0.82	0.72				
Q	0.60	0.70	0.65				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2018, Diodes Incorporated

www.diodes.com